



# Power MOSFETS

## DATASHEET

**LM40150NAI8A**

N-Channel  
Enhancement Mode MOSFET

- Leadpower-semiconductor Corp., Ltd
- sales@leadpower-semi.com
- (03) 6577339 FAX : (03) 6577229
- [www.leadpower-semi.com](http://www.leadpower-semi.com)



Quality Management Systems  
ISO 9001:2015 Certificate

# LM40150NAI8A

## N-Channel Enhancement Mode MOSFET

### Pin Description

### Product Summary

PDFN3.3*3.3 (TOP view)	Symbol	Symbol	N-Channel	Unit
Top View			$V_{DSS}$	40
Bottom View			$R_{DS(ON)-Max}$	16
			ID	A

### Feature

- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS Tested

### Applications

- Portable Equipment
- Power Management in Notebook Computer

### Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM40150NAI8A	PDFN3.3*3.3	Tape & Reel	5000 / Tape & Reel	40150 

Note : = Lot Code

### Absolute Maximum Ratings ( $T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter		N-Channel	Unit
$V_{DSS}$	Drain-Source Voltage		40	
$V_{GSS}$	Gate-Source Voltage		$\pm 20$	V
$T_J$	Maximum Junction Temperature		150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range		-55 to 150	$^\circ\text{C}$
$I_{DM}^{\circledR}$	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$	71	A
$I_D$	Continuous Drain Current	$T_c=25^\circ\text{C}$	31	A
		$T_c=100^\circ\text{C}$	20	
$P_D$	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	30	W
		$T_c=100^\circ\text{C}$	12	
$I_{AS}^{\circledR}$	Avalanche Current, Single pulse	$L=0.1\text{mH}$	18	A
$E_{AS}^{\circledR}$	Avalanche Energy, Single pulse	$L=0.1\text{mH}$	16	$\text{mJ}$

### Thermal Characteristics

Symbol	Parameter		Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	4.2	$^\circ\text{C/W}$
$R_{\theta JA}^{\circledR}$	Thermal Resistance-Junction to Ambient	Steady State	60	$^\circ\text{C/W}$

Note ① : Max. current is limited by bonding wire

Note ② : UIS tested and pulse width are limited by maximum junction temperature  $150^\circ\text{C}$

Note ③ : Surface Mounted on  $1\text{in}^2$  FR-4 board with 1oz

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## N-Channel Electrical Characteristics ( $T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics</b>						
<b><math>\text{BV}_{\text{DSS}}</math></b>	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{DS}}=250\mu\text{A}$	40	-	-	V
<b><math>I_{\text{DSS}}</math></b>	Zero Gate Voltage Drain Current	$V_{\text{DS}}=32\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
<b><math>V_{\text{GS(th)}}</math></b>	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=250\mu\text{A}$	1.2	1.7	2.1	V
<b><math>I_{\text{GSS}}</math></b>	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	$\text{nA}$
<b><math>R_{\text{DS(ON)}}^{\circledast}</math></b>	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{DS}}=20\text{A}$	-	12.5	16	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{DS}}=15\text{A}$	-	16	21	
<b><math>g_{\text{fs}}</math></b>	Forward Transconductance	$V_{\text{DS}}=5\text{V}, I_{\text{DS}}=10\text{A}$	-	11	-	S
<b>Dynamic Characteristics <sup>®</sup></b>						
<b><math>R_{\text{G}}</math></b>	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V},$ $\text{Freq.}=1\text{MHz}$	-	3.4	-	$\Omega$
<b><math>C_{\text{iss}}</math></b>	Input Capacitance	$V_{\text{GS}}=0\text{V},$ $V_{\text{DS}}=20\text{V},$ $\text{Freq.}=1\text{MHz}$	-	1048	-	$\text{pF}$
<b><math>C_{\text{oss}}</math></b>	Output Capacitance		-	83	-	
<b><math>C_{\text{rss}}</math></b>	Reverse Transfer Capacitance		-	64	-	
<b><math>t_{\text{d(ON)}}</math></b>	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=20\text{V},$ $I_{\text{D}}=1\text{A}, R_{\text{GEN}}=6\Omega$	-	5.7	-	$\text{nS}$
<b><math>t_{\text{r}}</math></b>	Turn-on Rise Time		-	21.2	-	
<b><math>t_{\text{d(OFF)}}</math></b>	Turn-off Delay Time		-	39.8	-	
<b><math>t_{\text{f}}</math></b>	Turn-off Fall Time		-	19.2	-	
<b><math>Q_{\text{g}}</math></b>	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}, V_{\text{DS}}=20\text{V}$ $I_{\text{D}}=20\text{A}$	-	12.6	-	$\text{nC}$
<b><math>Q_{\text{g}}</math></b>	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=20\text{V},$ $I_{\text{D}}=20\text{A}$	-	25.1	-	
<b><math>Q_{\text{gs}}</math></b>	Gate-Source Charge		-	1.5	-	
<b><math>Q_{\text{gd}}</math></b>	Gate-Drain Charge		-	6.8	-	
<b>Source-Drain Characteristics</b>						
<b><math>V_{\text{SD}}^{\circledast}</math></b>	Diode Forward Voltage	$I_{\text{SD}}=10\text{A}, V_{\text{GS}}=0\text{V}$	-	0.8	1.1	V
<b><math>t_{\text{rr}}</math></b>	Reverse Recovery Time	$I_{\text{F}}=10\text{A}, V_{\text{R}}=20\text{V}$	-	12.8	-	nS
<b><math>Q_{\text{rr}}</math></b>	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	6.2	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ ).

Note ⑤ : Guaranteed by design, not subject to production testing.

# LM40150NAI8A

## N-Channel Typical Characteristics

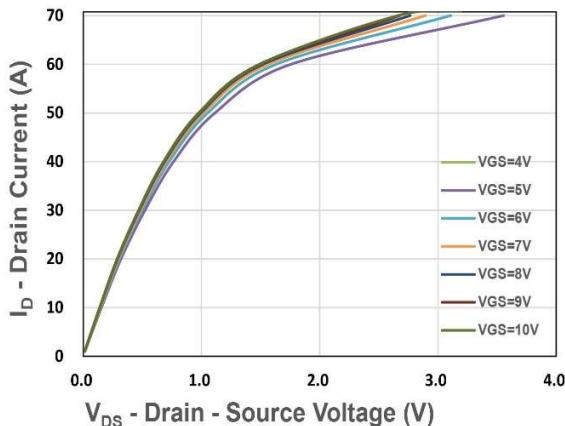


Figure 1. Output Characteristics

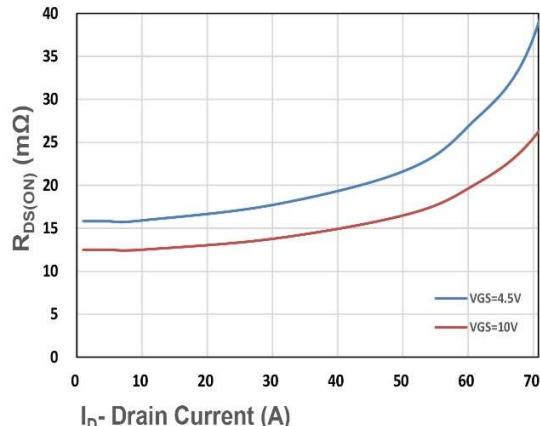


Figure 2. On-Resistance vs. ID

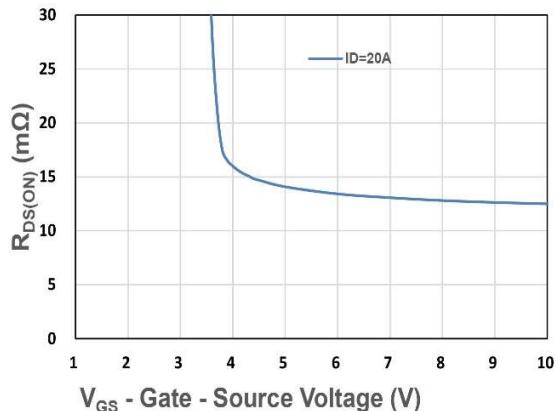


Figure 3. On-Resistance vs. VGS

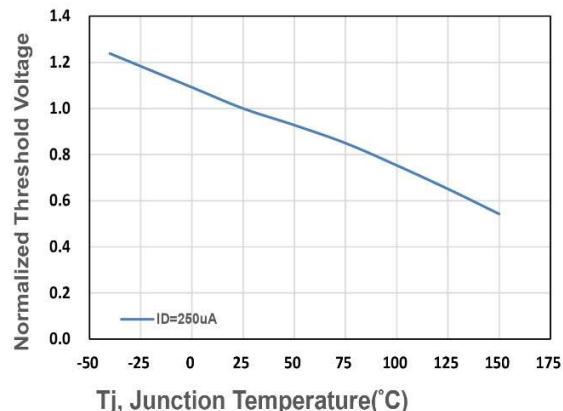


Figure 4. Gate Threshold Voltage

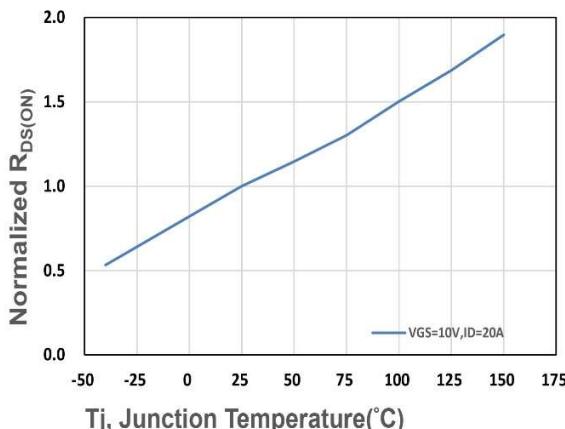


Figure 5. Drain-Source On Resistance

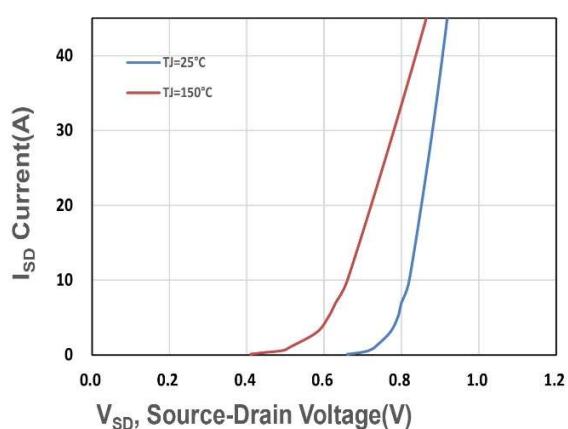


Figure 6. Source-Drain Diode Forward

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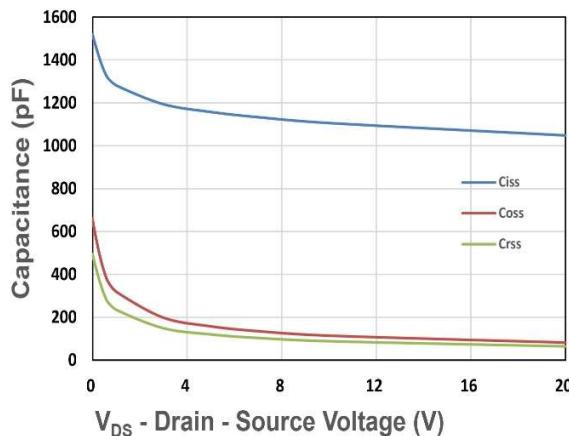


Figure 7. Capacitance

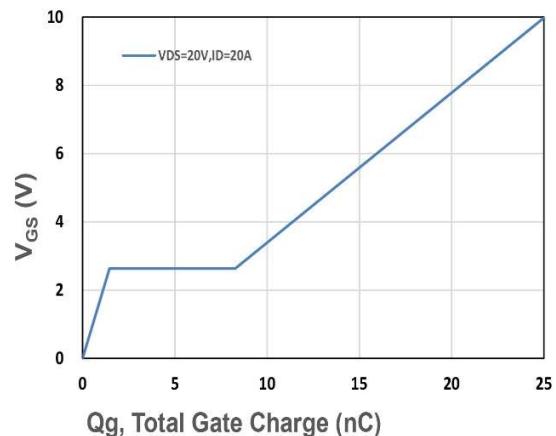


Figure 8. Gate Charge Characteristics

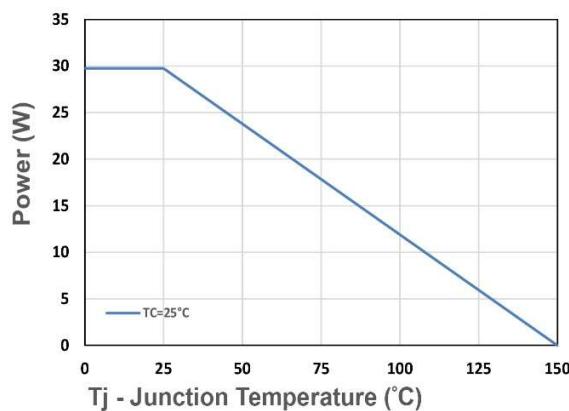


Figure 9. Power Dissipation

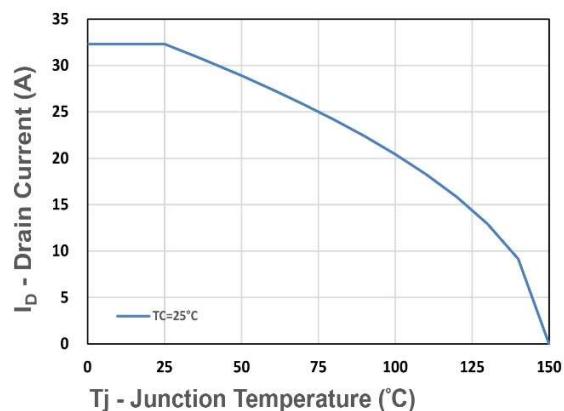


Figure 10. Drain Current

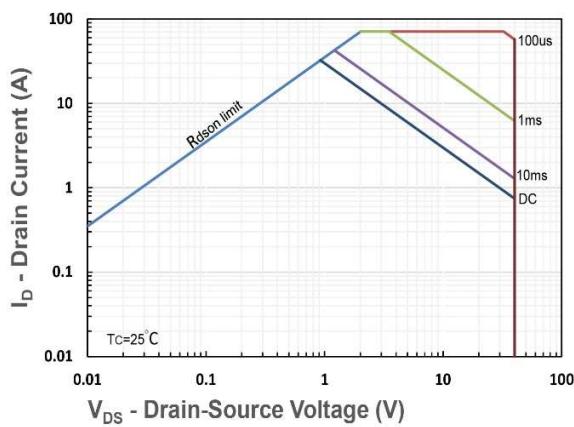


Figure 11. Safe Operating Area

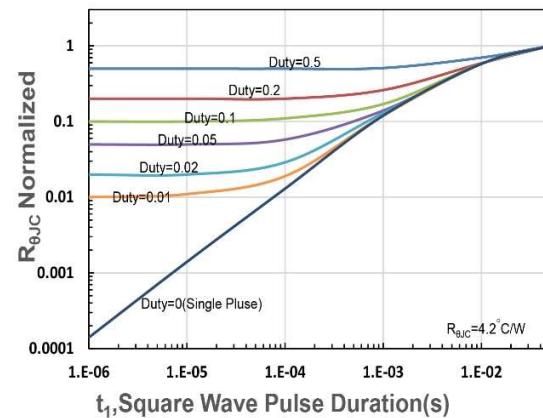


Figure 12.  $R_{θJC}$  Transient Thermal Impedance